National Semiconductor

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LMV116/LMV118
Low Voltage, 45MHz, Rail-to-Rail Output Operational Amplifiers with Shutdown Option

General Description

The LMV116 (single) rail-to-rail output voltage feedback amplifiers offer high speed (45MHz), and low voltage operation (2.7V) in addition to micro-power shutdown capability (LMV118).

Output voltage range extends to within 20mV of either supply rail, allowing wide dynamic range especially in low voltage applications. Even with low supply current of 600µA, output current capability is kept at a respectable ±20mA for driving heavier loads. Important device parameters such as BW, Slew Rate and output current are kept relatively independent of the operating supply voltage by a combination of process enhancements and design architecture.

For portable applications, the LMV118 provides shutdown capability while keeping the turn-off current to l5µA. Both turn-on and turn-off characteristics are well behaved with minimal output fluctuations during transitions. This allows the part to be used in power saving mode, as well as multiplexing applications. Miniature packages (SOT23-5 & SOT23-6) are further means to ease the adoption of these low power high speed devices in applications where board area is at a premium.

Features

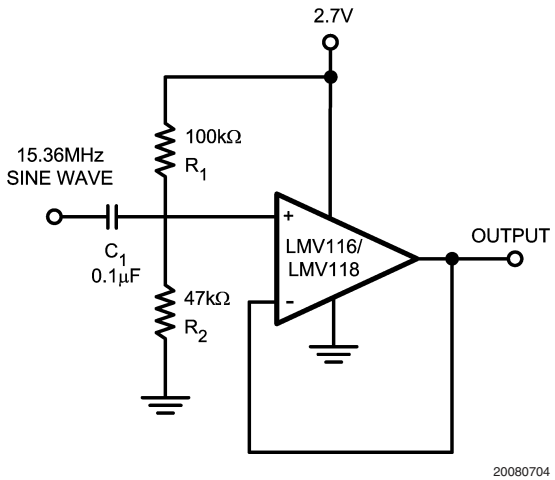
(V_S = 2.7V, T_A = 25˚C, R_L = 1kΩ to V^+/2, A_V = +1. Typical values unless specified).

- –3dB BW 45MHz
- Supply voltage range 2.7V to 12V
- Slew rate 40V/µs
- Supply current 600µA
- Power down supply current 15µA
- Output short circuit current 32mA
- Linear output current ±20mA
- Input common mode voltage –0.3V to 1.7V
- Output voltage swing 20mV from rails
- Input voltage noise 40nV/$\sqrt{Hz}$
- Input current noise 0.75pA/$\sqrt{Hz}$

Applications

- High speed clock buffer/driver
- Active filters
- High speed portable devices
- Multiplexing applications (LMV118)
- Current sense amplifier
- High speed transducer amplifier

Typical Application



Non-Inverting Clock Buffer Amplifier

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

ESD Tolerance	
Human Body	2KV (Note 2)
Machine Model	200V (Note 9)
V_{IN} Differential	±2.5V
Output Short Circuit Duration	(Note 3), (Note 11)
Supply Voltage (V^+ - V^-)	12.6V
Voltage at Input/Output pins	V^+ +0.8V, V^- −0.8V
Storage Temperature Range	−65˚C to +150˚C
Junction Temperature (Note 4)	+150˚C
Soldering Information	
Infrared or Convection (20 sec)	235˚C
Wave Soldering Lead Temp. (10 sec)	260˚C

Operating Ratings (Note 1)

Supply Voltage ($V^+ - V^-$)	2.5V to 12V
Temperature Range (Note 4)	−40˚C to +85˚C
Package Thermal Resistance (Note 4) (θ_{JA})	
SOT23-5	265˚C/W
SOT23-6	265˚C/W

2.7V Electrical Characteristics

Unless otherwise specified, all limits guaranteed for at T_J = 25˚C, V^+ = 2.7V, V^- = 0V, $V_{CM} = V_O = V^+/2$, and R_F = 2kΩ, and R_L = 1kΩ to $V^+/2$. **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Min (Note 6)	Typ (Note 5)	Max (Note 6)	Units
V_{OS}	Input Offset Voltage	0V ≤ V_{CM} ≤ 1.7V		±1	±5 **±6**	mV
TC V_{OS}	Input Offset Average Drift	(Note 12)		±5		µV/C
I_B	Input Bias Current	(Note 7)	−2.0 **−2.2**	−0.40		µA
I_{OS}	Input Offset Current			1	500	nA
CMRR	Common Mode Rejection Ratio	V_{CM} Stepped from 0V to 1.55V	73	88		dB
PSRR	Power Supply Rejection Ratio	V^+ = 2.7V to 3.7V or V^- = 0V to −1V	72	85		dB
R_{IN}	Common Mode Input Resistance			3		MΩ
C_{IN}	Common Mode Input Capacitance			2		pF
CMVR	Input Common-Mode Voltage Range	CMRR ≥ 50dB	−0.3 **−0.1**		1.7	V
A_{VOL}	Large Signal Voltage Gain	V_O = 0.35V to 2.35V	73 **70**	87		dB
V_O	Output Swing High	R_L = 1kΩ to $V^+/2$	2.55	2.66		V
		R_L = 10kΩ to $V^+/2$		2.68		
	Output Swing Low	R_L = 1kΩ to $V^+/2$	150	40		mV
		R_L = 10kΩ to $V^+/2$		20		
I_{SC}	Output Short Circuit Current	Sourcing to V^- V_{ID} = 200mV (Note 10)	25	35		mA
		Sinking to V^+ V_{ID} = −200mV (Note 10)	25	32		
I_{OUT}	Output Current	V_{OUT} = 0.5V from rails		±20		mA
I_S	Supply Current	Normal Operation		600	900	µA
		Shut-down Mode (LMV118)		15	50	
SR	Slew Rate (Note 8)	A_V = +1, $V_O = 1V_{PP}$		40		V/µs
BW	−3dB BW	A_V = +1, $V_{OUT} = 200mV_{PP}$		45		MHz
e_n	Input -Referred Voltage Noise	f = 100kHz		40		nV/$\sqrt{Hz}$
		f = 1kHz		60		

2.7V Electrical Characteristics (Continued)

Unless otherwise specified, all limits guaranteed for at T_J = 25˚C, V^+ = 2.7V, V^- = 0V, $V_{CM} = V_O = V^+/2$, and R_F = 2kΩ, and R_L = 1kΩ to $V^+/2$. **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Min (Note 6)	Typ (Note 5)	Max (Note 6)	Units
i_n	Input-Referred Current Noise	f = 100kHz		0.75		pA/$\sqrt{Hz}$
		f = 1kHz		1.20		
t_{on}	Turn-on Time (LMV118)			250		ns
t_{off}	Turn-off Time (LMV118)			560		ns
TH_{SD}	Shut-down Threshold (LMV118)	$I_S \leq 50\mu A$		1.95	2.3	V
I_{SD}	Shutdown Pin Input Current (LMV118)	(Note 7)		–20		µA

5V Electrical Characteristics

Unless otherwise specified, all limits guaranteed for at T_J = 25˚C, V^+ = 5V, V^- = 0V, $V_{CM} = V_O = V^+/2$, and R_F = 2kΩ, and R_L = 1kΩ to $V^+/2$. **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Min (Note 6)	Typ (Note 5)	Max (Note 6)	Units
V_{OS}	Input Offset Voltage	$0V \leq V_{CM} \leq 1.7V$		±1	±5 **±6**	mV
TC V_{OS}	Input Offset Average Drift	(Note 12)		±5		µV/C
I_B	Input Bias Current	(Note 7)	–2.0 **–2.2**	–0.40		µA
I_{OS}	Input Offset Current			1	500	nA
CMRR	Common Mode Rejection Ratio	V_{CM} Stepped from 0V to 3.8V	77	85		dB
PSRR	Power Supply Rejection Ratio	V^+ = 5V to 6V or V^- = 0V to –1V	72	95		dB
R_{IN}	Common Mode Input Resistance			3		MΩ
C_{IN}	Common Mode Input Capacitance			2		pF
CMVR	Input Common-Mode Voltage Range	CMRR ≥ 50dB	–0.3 **–0.1**		4.0	V
A_{VOL}	Large Signal Voltage Gain	V_O = 1.5V to 3.5V	73 **70**	85		dB
V_O	Output Swing High	R_L = 1kΩ to $V^+/2$	4.80	4.95		V
		R_L = 10kΩ to $V^+/2$		4.98		
	Output Swing Low	R_L = 1kΩ to $V^+/2$	200	50		mV
		R_L = 10kΩ to $V^+/2$		20		
I_{SC}	Output Short Circuit Current	Sourcing to V^- V_{ID} = 200mV (Note 10)	35	45		mA
		Sinking to V^+ V_{ID} = –200mV (Note 10)	35	43		
I_{OUT}	Output Current	V_{OUT} = 0.5V from rails		±20		mA
I_S	Supply Current	Normal Operation		600	900	µA
		Shut-down Mode (LMV118)		10	50	
SR	Slew Rate (Note 8)	A_V = +1, $V_O = 1V_{PP}$		40		V/µs
BW	–3dB BW	A_V = +1, $V_{OUT} = 200mV_{PP}$		45		MHz
e_n	Input -Referred Voltage Noise	f = 100kHz		40		nV/$\sqrt{Hz}$
		f = 1kHz		60		
i_n	Input-Referred Current Noise	f = 100kHz		0.75		pA/$\sqrt{Hz}$
		f = 1kHz		1.20		

5V Electrical Characteristics (Continued)

Unless otherwise specified, all limits guaranteed for at T_J = 25˚C, V^+ = 5V, V^- = 0V, V_{CM} = V_O = V^+/2, and R_F = 2kΩ, and R_L = 1kΩ to V^+/2. **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Min (Note 6)	Typ (Note 5)	Max (Note 6)	Units
t_{on}	Turn-on Time (LMV118)			210		ns
t_{off}	Turn-off Time (LMV118)			500		ns
TH_{SD}	Shut-down Threshold (LMV118)	$I_S \leq 50\mu A$		4.25	4.60	V
I_{SD}	Shutdown Pin Input Current (LMV118)	(Note 7)		–20		µA

±5V Electrical Characteristics

Unless otherwise specified, all limits guaranteed for at T_J = 25˚C, V^+ = 5V, V^- = –5V, V_{CM} = V_O = 0V, and R_F = 2kΩ, and R_L = 1kΩ to V^+/2. **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Min (Note 6)	Typ (Note 5)	Max (Note 6)	Units
V_{OS}	Input Offset Voltage	$-5V \leq V_{CM} \leq 1.7V$		±1	±5 **±6**	mV
TC V_{OS}	Input Offset Average Drift	(Note 12)		±5		µV/C
I_B	Input Bias Current	(Note 7)	–2.0 **–2.2**	–0.40		µA
I_{OS}	Input Offset Current			3	500	nA
CMRR	Common Mode Rejection Ratio	V_{CM} Stepped from –5V to 3.5V	78	104		dB
PSRR	Power Supply Rejection Ratio	V^+ = 5V to 6V or V^- = –5V to –6V	72	95		dB
R_{IN}	Common Mode Input Resistance			3		MΩ
C_{IN}	Common Mode Input Capacitance			2		pF
CMVR	Input Common-Mode Voltage Range	CMRR ≥ 50dB	–5.3 **–5.1**		4.0	V
A_{VOL}	Large Signal Voltage Gain	V_O = –2V to 2V	74 **71**	85		dB
V_O	Output Swing High	R_L = 1kΩ	4.70	4.92		V
		R_L = 10kΩ		4.97		
	Output Swing Low	R_L = 1kΩ	–4.70	–4.93		mV
		R_L = 10kΩ		–4.98		
I_{SC}	Output Short Circuit Current	Sourcing to 0V V_{ID} = 200mV (Note 10)	40	57		mA
		Sinking to 0V V_{ID} = –200mV (Note 10)	40	54		
I_{OUT}	Output Current	V_{OUT} = 0.5V from rails		±20		mA
I_S	Supply Current	Normal Operation		600	900	µA
		Shut-down Mode (LMV118)		15	50	
SR	Slew Rate (Note 8)	A_V = +1, V_O = $1V_{PP}$		35		V/µs
BW	–3dB BW	A_V = +1, V_{OUT} = $200mV_{PP}$		45		MHz
e_n	Input -Referred Voltage Noise	f = 100kHz		40		nV/ $\sqrt{Hz}$
		f = 1kHz		60		
i_n	Input-Referred Current Noise	f = 100kHz		0.75		pA/ $\sqrt{Hz}$
		f = 1kHz		1.20		
t_{on}	Turn-on Time (LMV118)			200		ns
t_{off}	Turn-off Time (LMV118)			700		ns

±5V Electrical Characteristics (Continued)

Unless otherwise specified, all limits guaranteed for at T_J = 25˚C, V^+ = 5V, V^- = –5V, V_{CM} = V_O = 0V, and R_F = 2kΩ, and R_L = 1kΩ to V^+/2. **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Min (Note 6)	Typ (Note 5)	Max (Note 6)	Units
TH_{SD}	Shut-down Threshold (LMV118)	$I_S \leq 50\mu A$		4.25	4.60	V
I_{SD}	Shutdown Pin Input Current (LMV118)	(Note 7)		–20		µA

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not guaranteed. For guaranteed specifications and the test conditions, see the Electrical Characteristics.

Note 2: Human body model, 1.5kΩ in series with 100pF.

Note 3: Applies to both single-supply and split-supply operation. Continuous short circuit operation at elevated ambient temperature can result in exceeding the maximum allowed junction temperature of 150˚C.

Note 4: The maximum power dissipation is a function of $T_{J(MAX)}$, θ_{JA}, and T_A. The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(MAX)} - T_A)/ \theta_{JA}$. All numbers apply for packages soldered directly onto a PC board.

Note 5: Typical values represent the most likely parametric norm.

Note 6: All limits are guaranteed by testing or statistical analysis.

Note 7: Positive current corresponds to current flowing into the device.

Note 8: Slew rate is the average of the rising and falling slew rates.

Note 9: Machine Model, 0Ω in series with 200pF.

Note 10: Short circuit test is a momentary test. See Note 11.

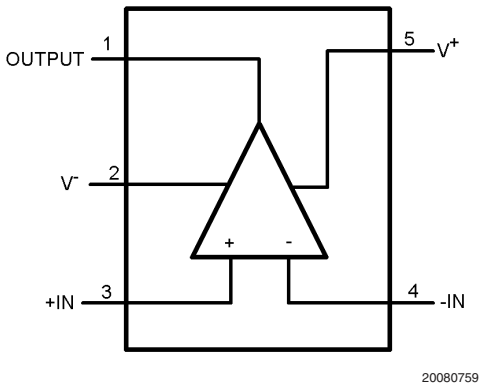
Note 11: Output short circuit duration is infinite for V_S < 6V at room temperature and below. For V_S > 6V, allowable short circuit duration is 1.5ms.

Note 12: Offset voltage average drift determined by dividing the change in V_{OS} at temperature extremes into the total temperature change.

Note 13: Guaranteed based on characterization only.

Connection Diagrams

SOT23-5 (LMV116)



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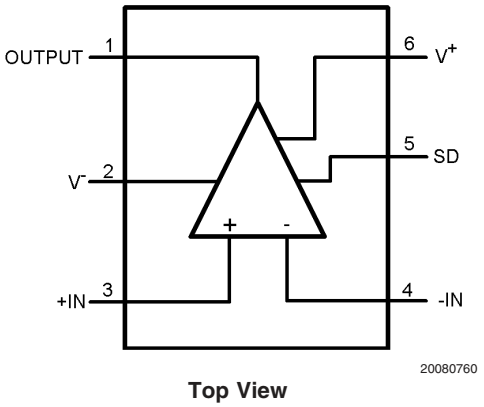
Top View

SOT23-6 (LMV118)



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Top View

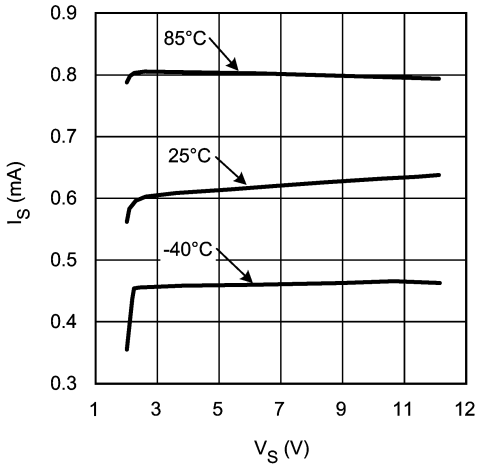
Ordering Information

Package	Part Number	Package Marking	Transport Media	NSC Drawing
5-Pin SOT-23	LMV116MF	AC1A	1k Units Tape and Reel	MF05A
	LMV116MFX		3k Units Tape and Reel	
6-Pin SOT-23	LMV118MF	AD1A	1k Units Tape and Reel	MF06A
	LMV118MFX		3k Units Tape and Reel	

Typical Performance Characteristics

At T_J = 25˚C. Unless otherwise specified.

Supply Current vs. Supply Voltage



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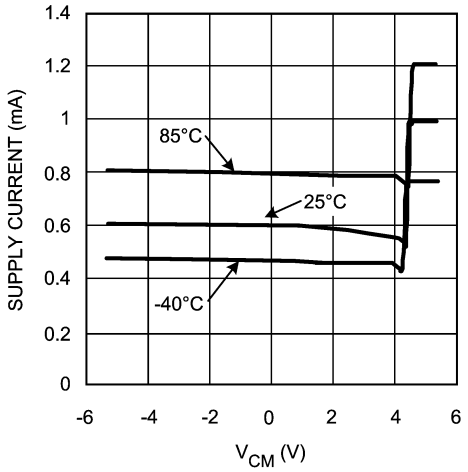
Supply Current vs. V_{CM}



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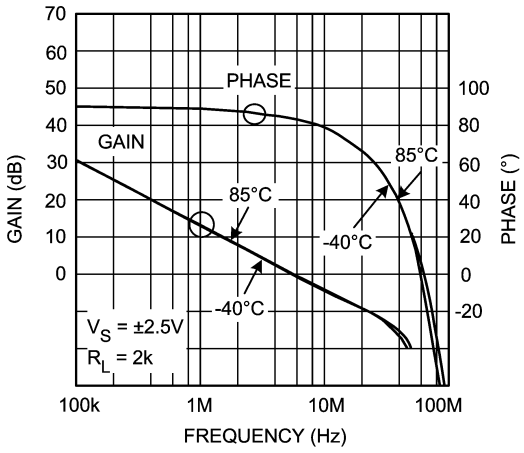
Gain and Phase vs. Frequency



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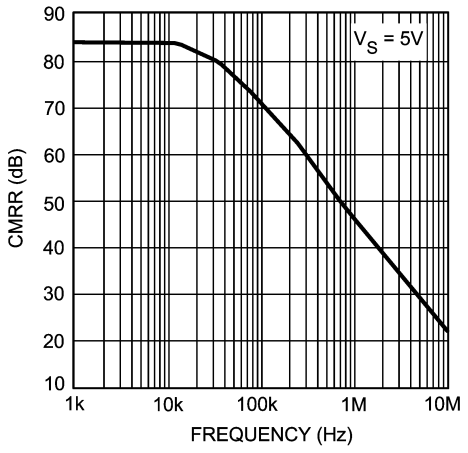
CMRR vs. Frequency



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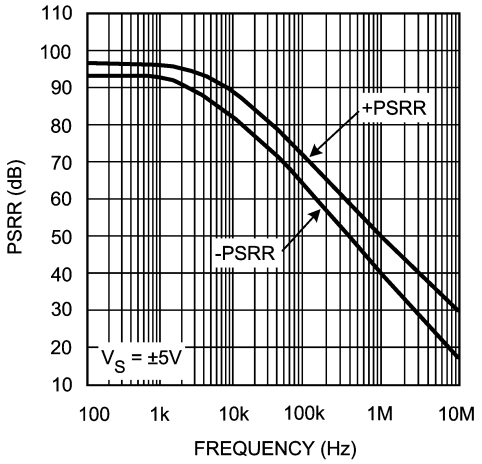
PSRR vs. Frequency



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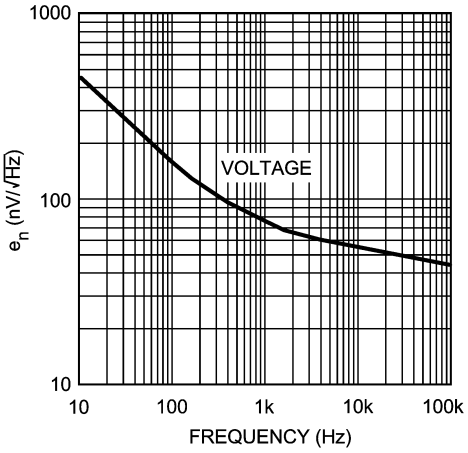
Input Voltage Noise vs. Frequency



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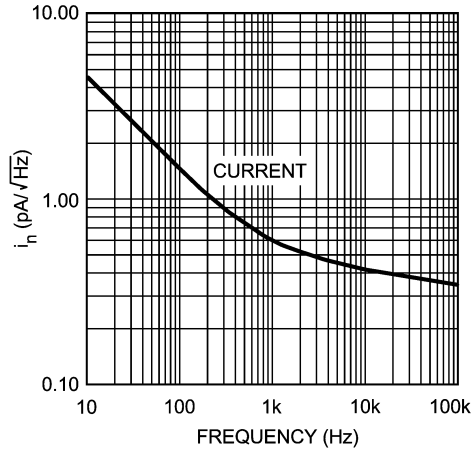
Typical Performance Characteristics At T_J = 25˚C. Unless otherwise specified. (Continued)

Input Current Noise vs. Frequency



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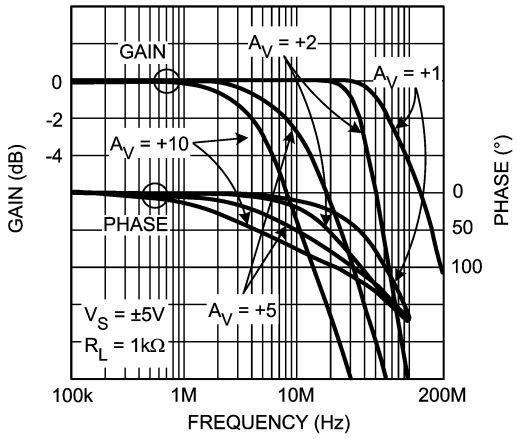
Closed Loop Frequency Response for Various Temperature



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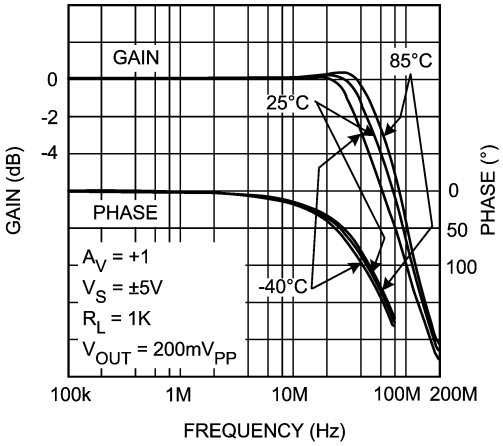
Frequency Response for Various (A_V)



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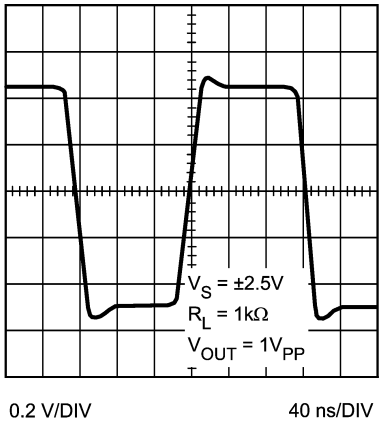
Large Signal Step Response



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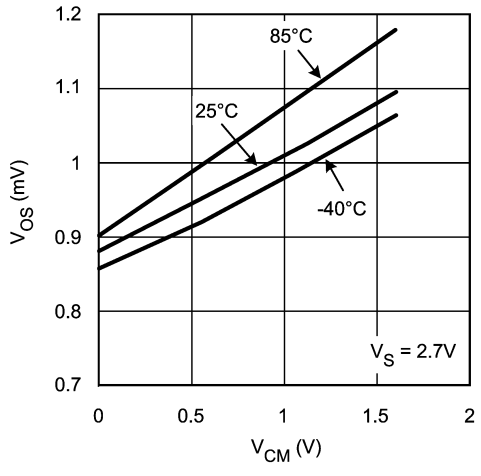
Offset Voltage vs. Common Mode Voltage (A Typical Unit)



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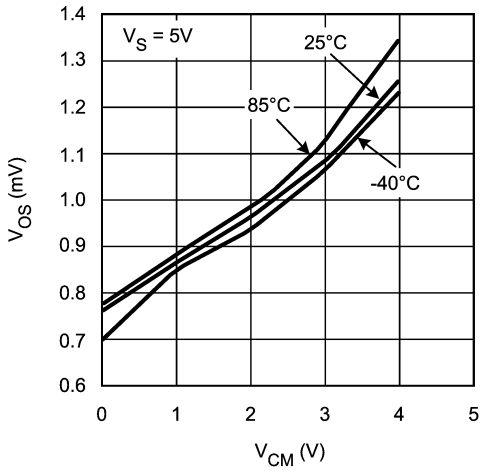
Offset Voltage vs. Common Mode Voltage (A Typical Unit)



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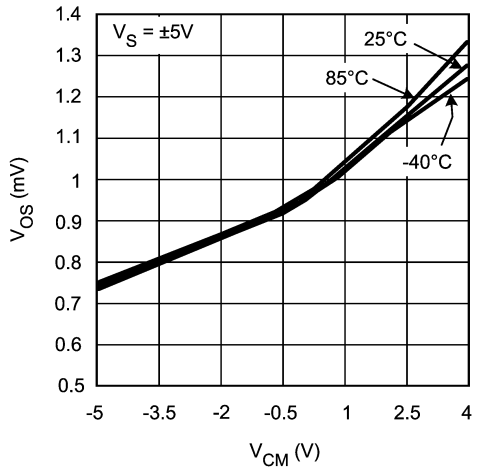
Typical Performance Characteristics At T_J = 25˚C. Unless otherwise specified. (Continued)

Offset Voltage vs. Common Mode Range (A Typical Unit)



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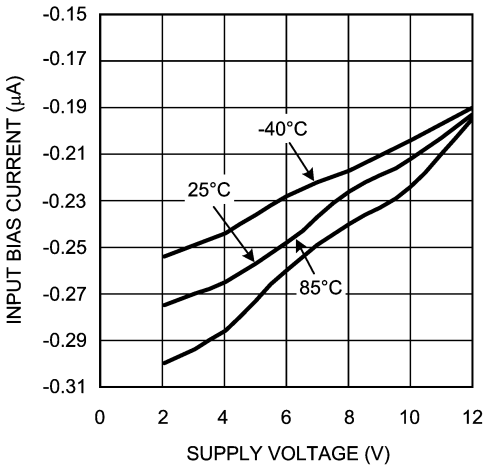
Input Bias Current vs. Supply Voltage



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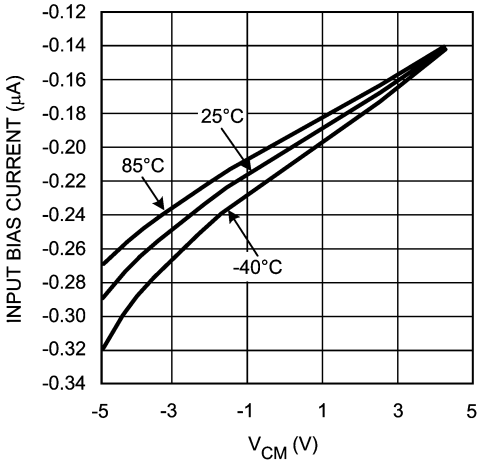
Input Bias Current vs. V_{CM}



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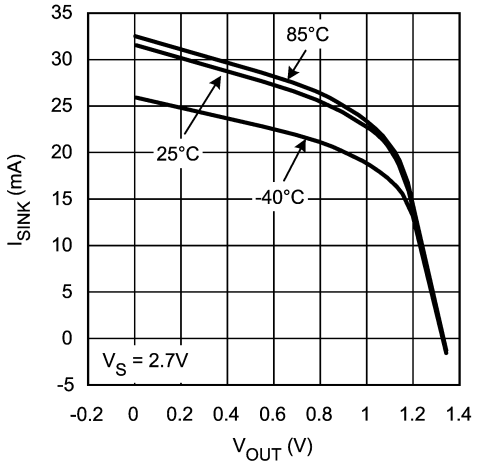
Sink Current vs. V_{OUT}



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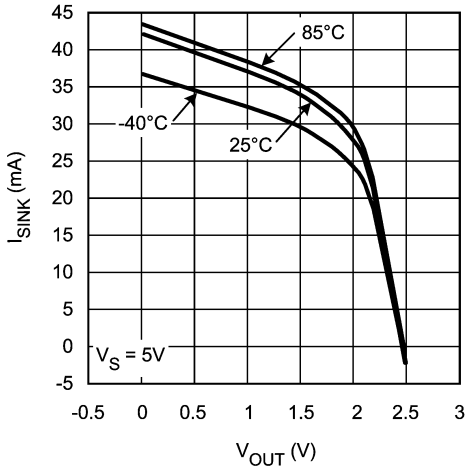
Sink Current vs. V_{OUT}



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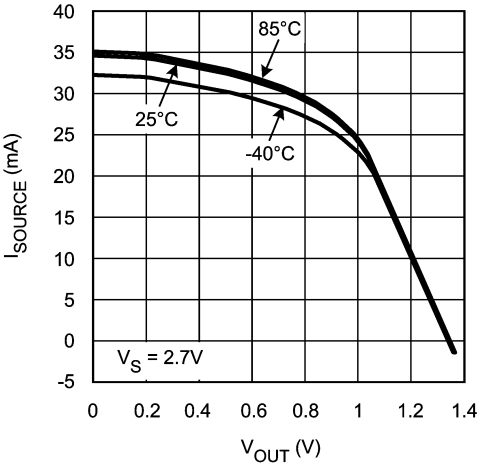
Souce Current vs. V_{OUT}



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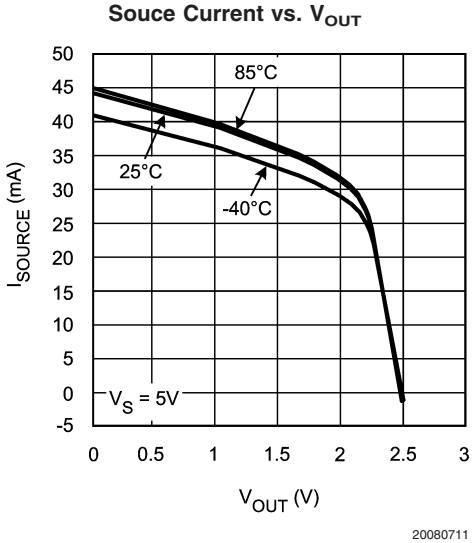
Typical Performance Characteristics At T_J = 25˚C. Unless otherwise specified. (Continued)



Application Notes

CIRCUIT DESCRIPTION

The LMV116 and LMV118 are based on National Semiconductor's proprietary VIP10 dielectrically isolated bipolar process.

The LMV116 and LMV118 architecture features the following:

- Complimentary bipolar devices with exceptionally high f_t (~8GHz) even under low supply voltage (2.7V) and low Collector bias current.
- Common Emitter push-pull output stage capable of 20mA output current (at 0.5V from the supply rails) while consuming only 600µA of total supply current. This architecture allows output to reach within milli-volts of either supply rail at light loads.
- Consistent performance from any supply voltage (2.7V-10V) with little variation with supply voltage for the most important specifications (e.g. BW, SR, I_{OUT}, etc.)

MICRO-POWER SHUTDOWN

The LMV118 can be shutdown to save power and reduce its supply current to less than 50µA guaranteed, by applying a voltage to the SD pin. The SD pin is "active high" and needs to be tied to V^- for normal operation. This input is low current (<20µA, 4pF equivalent capacitance) and a resistor to V^- (≤20kΩ) will result in normal operation. Shutdown is guaranteed when SD pin is 0.4V or less from V^+ at any operating supply voltage and temperature.

In the shutdown mode, essentially all internal device biasing is turned off in order to minimize supply current flow and the output goes into Hi-Z (high impedance) mode. Complete device Turn-on and Turn-off times vary considerably relative to the output loading conditions, output voltage, and input impedance, but is generally limited to less than 1µs (see tables for actual data).

During shutdown, the input stage has an equivalent circuit as shown below in *Figure 1*

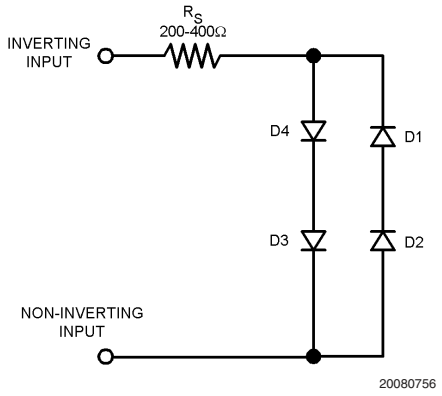


FIGURE 1. LMV118 Equivalent Input in Shutdown Mode

As can be seen above, in shutdown, there may be current flow through the internal diodes shown, caused by input potential, if present. This current may flow through the external feedback resistor and result in an apparent output signal. In most shutdown applications the presence of this output is inconsequential. However, if the output is "forced" by another device such as in a multiplexer, the other device will need to conduct the current described in order to maintain the output potential.

To keep the output at or near ground during shutdown when there is no other device to hold the output low, a switch (transistor) could be used to shunt the output to ground. *Figure 2* shows a circuit where a NPN bipolar is used to keep the output near ground (~80mV):

Application Notes (Continued)

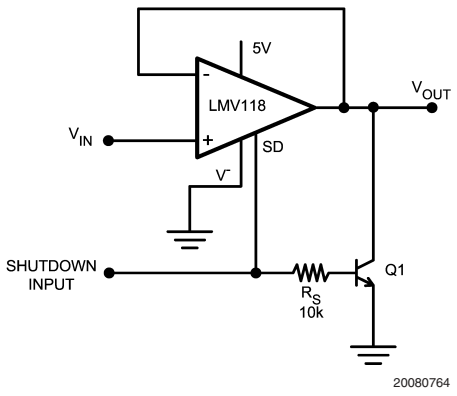


FIGURE 2. Active Pull-Down Schematic

Figure 3 shows the output waveform.

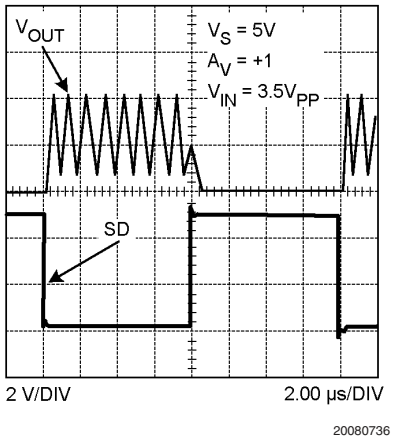


FIGURE 3. Output Held Low by Active Pull-Down Circuit

If bipolar transistor power dissipation is not tolerable, the switch could be by a N-channel enhancement mode MOSFET.

2.7V SINGLE SUPPLY 2:1 MUX

The schematic show in *Figure 4* will function as a 2:1 MUX operating on a single 2.7V power supply, by utilizing the shutdown feature of the LMV118.

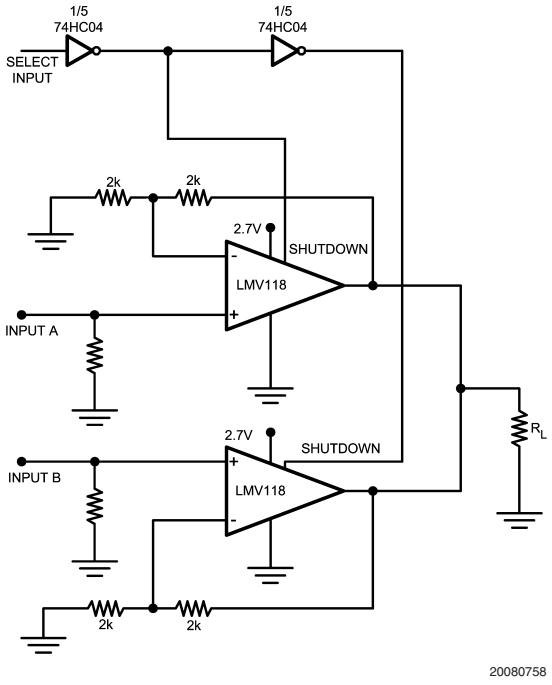


FIGURE 4. 2:1 MUX Operating off a 2.7V Single Supply

Figure 5 shows the MUX output when selecting between a 1MHz sine and a 250kHz triangular waveform.

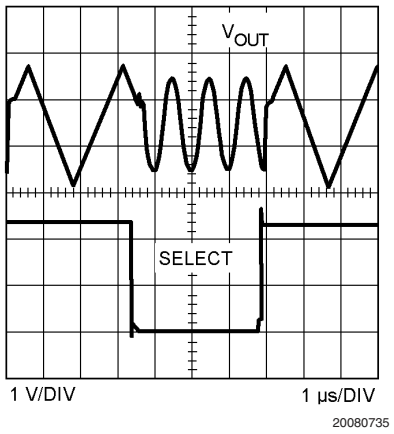


FIGURE 5. 2:1 MUX Output

As can be seen in *Figure 5*, the output is well behaved and there are no spikes or glitches due to the switching. Switching times are approximately around 500ns based on the time when the output is considered “valid”.

Application Notes (Continued)

PRINTED CIRCUIT BOARD LAYOUT, COMPONENT VALUES SELECTION, AND EVALUATION BOARDS

Generally, a good high-frequency layout will keep power supply and ground traces away from the inverting input and output pins. Parasitic capacitances on these nodes to ground will cause frequency response peaking and possible circuit oscillations (see Application Note OA-15 for more information).

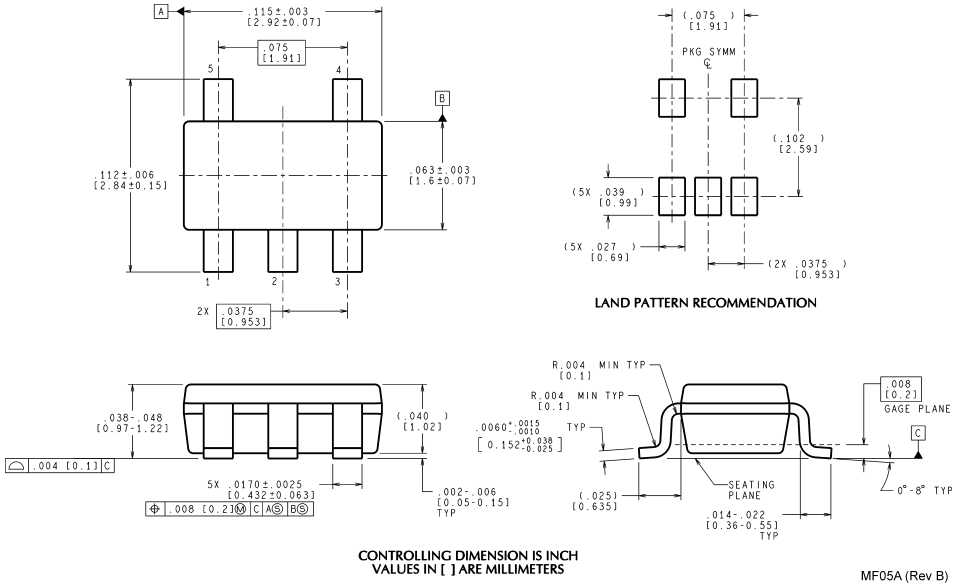
Another important parameter, is the component values selection. Choosing large valued external resistors, will effect the closed loop behavior of the stage because of the interaction of these resistors with parasitic capacitances. These capacitors could be inherent to the device or a by-product of the board layout and component placement. Either way, keeping the resistor values lower, will diminish this interaction. On the other hand, choosing very low value resistors could load down nodes and will contribute to higher overall power dissipation.

National Semiconductor suggests the following evaluation boards as a guide for high frequency layout and as an aid in device testing and characterization:

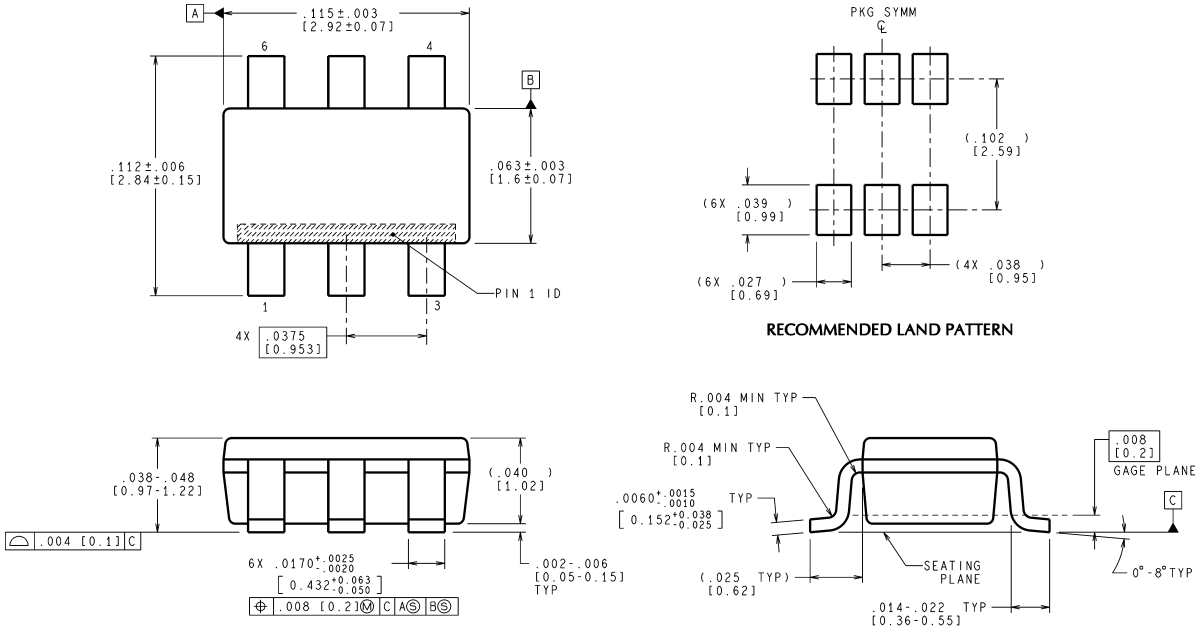
Device	Package	Evaluation Board PN
LMV116	SOT23-5	CLC730068
LMV118	SOT23-6	CLC730116

These free evaluation boards are shipped when a device sample request is placed with National Semiconductor.

Physical Dimensions inches (millimeters) unless otherwise noted



5-Pin SOT23
NS Package Number MF05A



6-Pin SOT23
NS Package Number MF06A

Notes

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